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SPECIFICATION

CUSTOMER :		
MODULE NO.:	WF35NTVA	JDNNO#
	4	
APPROVED BY:	20/1/	
(FOR CUSTOMER USE ONLY)	(5)	
	PCB VERSION:	DATA:

SALES BY APPROVED BY	CHECKED BY	PREPARED BY
		葉虹蘭

ISSUED DATE: 2016/01/21



MODLE NO:

RECORDS OF REVISION		DOC. FIRST ISSUE	
VERSION	DATE	REVISED PAGE NO.	SUMMARY
0	2015/02/03		First issue
A	2015/03/16		Remove the description of
			TFT color part
В	2015/04/27		Modify Reliability.
C	2015/11/02		Modify Initial Code.
D	2016/01/21		Modify Static electricity test

Contents

- 1.Module Classification Information
- 2.Summary
- 3. General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
- 6.DC Characteristics
- 7.AC Characteristics
- 8. Optical Characteristics
- 9.Interface
- 10.Block Diagram
- 11.Reliability
- 12.Contour Drawing
- 13.Initial Code For Reference

1.Module Classification Information

W F 35 V J D N 0 N T A N (1) 2 3 4 (5) 6 7 8 9 (11) (12) 13)

①	Brand: WINSTAR	DISPLAY COR	PORATION						
2	Display Type: F→TFT Type, J→Custom TFT								
3	Display Size: 3.5" TFT								
4	Model serials no.								
(5)	Backlight Type:	F→CCFL, Whit	ie	T→LED, V	White	1.0			
		S→LED, High I	Light White			4			
6	LCD Polarize	C→Transmissiv	e, N. T, 6:00;	→Transmis	sive, W. T, 6:0	0			
	Type/ Temperature	F→Transmissiv	e, N.T,12:00 ; I	.→Transmi	ssive, W.T,12:0)0			
	range/ Gray Scale	N→Transmissiv	e, Super W.T, 6	5:00	20				
	Inversion Direction	Q→Transmissiv	e, Super W.T,	2:00)			
		X→Transmissiv	e, W.T, VATF	Γ					
		V→Transmissiv	e, Super W.T,	VA TFT					
		R→Transmissiv	e, Super W.T, O	O-TFT	Y				
		Z→Transmissiv	e, W.T, O-TFT		7				
		A→Transmissiv	e, N.T, IPS TF	Ţ					
		Y→Transmissiv	e, W.T, IPS TF						
7	A: TFT LCD		17	G: TFT	+FR				
	B: TFT+FR+CON	TROL BOARD	C) Y.	H: TFT	+D/V BOAR	D			
	C:TFT+FR+A/DI			I: TFT+	FR+D/V BO	ARD			
	D: TFT+FR+A/D	BOARD+CONT	ROL BOARD	J: TFT+	POWER BD				
	E: TFT+FR+POW		,						
	F: TFT+CONTRO	L BOARD							
8	Resolution:			ı	1	T			
	A: 128160 B:3202	234 C:320240	D:480234	E:480272	F: 640480	G: 800480			
	H:1024600 I:32048	80 J:240320	K:800600	L:240400	M:1024768	P:1280800			
	S:480128 T:8003								
9	D: Digital L: LV	/DS							
10	Interface: N:w	ithout control bo	ard A:8Bit	B: 16Bi	t				
11)	TS: N: Without T	S T: resistive	e touch panel	C: capa	citive touch pa	nel (G-F-F)			
	G: capacitive	touch panel(G-G	-	•	1	. ,			
12	Version								
13	Special Code	#:Fit in with RO	HS directive re	gulations					
		<u> </u>							

2.Summary

This technical specification applies to 3.45' Mono TFT-LCD panel. The 3.45' Mono TFT-LCD panel is designed for camcorder, digital camera application and other electronic products which require high quality flat panel displays. This module follows RoHS.

WF35NTVAJDNN0#

3.General Specifications

Item	Dimension	Unit
Size	3.5	inch
Dot Matrix	240 x 320	dots
Module dimension	62.9 x 86.54 x 4.1	mm
Active area	53.28 x 71.04	mm
Dot pitch	0.222 x 0. 222	mm
LCD type	TFT, Mono Transmissive	
View Direction	Wide View	
Gray Scale	16 Gray scale (4BPP)/ 4 Gray scale (2BPP)/ 2 Gr	ray scale (1BPP)
Driver IC	ST7511	
Backlight Type	LED, Normally White	
With /Without TP	Without TP	
Surface	Glare	

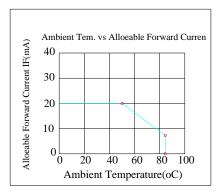
^{*} Mono tone slight changed by temperature and driving voltage.

4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	TOP	-30	_	+80	$^{\circ}\!\mathbb{C}$
Storage Temperature	TST	-30	_	+80	$^{\circ}\!\mathbb{C}$

Note: Device is subject to be damaged permanently if stresses beyond those absolute maximum ratings listed above

1. Temp. $\leq 60^{\circ}$ C, 90% RH MAX. Temp. $> 60^{\circ}$ C, Absolute humidity shall be less than 90% RH at 60° C



5.Electrical Characteristics

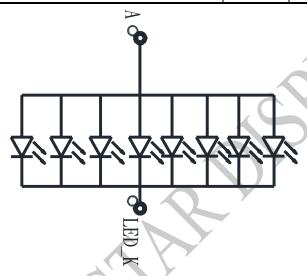
5.1. Operating conditions:

Item	Symbol	Condition	Min	Тур	Max	Unit	Remark
Supply Voltage For LCM	VDD	_	3.0	3.3	3.6	V	
Supply Current For LCM	IDD	_	_	13	_	mA	Note1
Power Consumption	_	_	_	_	46.8	mW∧	

Note1: This value is test for VDD=3.3V only

5.2. LED driving conditions

Parameter	Symbol	Min.	Typ.	Max.	Unit	Remark
LED current		_	160	-	mA	
Power Consumption		_	- (- (mW	
LED voltage	A-K	2.8	3.0	3.3	V	Note 1
LED Life Time		_	50,000		Hr	Note 2,3,4



Note 1 : Power supply the back light specification

Note $2: Ta = 25 \, ^{\circ}C$

Note 3: Brightness to be decreased to 50% of the initial value

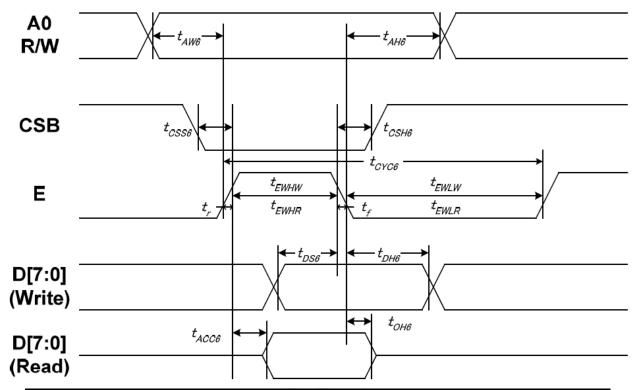
Note 4: The single LED lamp case

6.DC CHARATERISTICS

Parameter	Symbol		Rating			Condition
Tarameter	Symbol	Min Typ Max		Unit	Condition	
Low level input voltage	VIL	0	-	0.3VDD	V	
High level input voltage	V _{IH}	0.7VDD	-	VDD	V	

7.AC CHARATERISTICS

7.1. System Bus Timing for 6800 Series MPU



Item	Signal	Symbol	Condition	Min	Max	Unit
Address setup time	A0	tAW6	-	10	-	
Address hold time	AU	tAH6	-	0	-	
System cycle time		tCYC6	ı	200	-	
Enable L pulse width (WRITE)		tEWLW	1	100	-	
Enable H pulse width (WRITE)	Е	tEWHW	ı	100	-	
Enable L pulse width (READ)		tEWLR	ı	130	-	
Enable H pulse width (READ)		tEWHR	ı	130	-	ns
CSB setup time	CSB	tCSS6	ı	100	-	
CSB hold time	CSB	tCSH6	-	100	-	
Write data setup time		tDS6	-	70	-	
Write data hold time	D[7.0]	tDH6	-	20	-	
Read data access time	D[7:0]	tACC6	CL = 100 pF	-	80	
Read data output disable time		tOH6	CL = 100 pF	15	80	

Note:

1. The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time

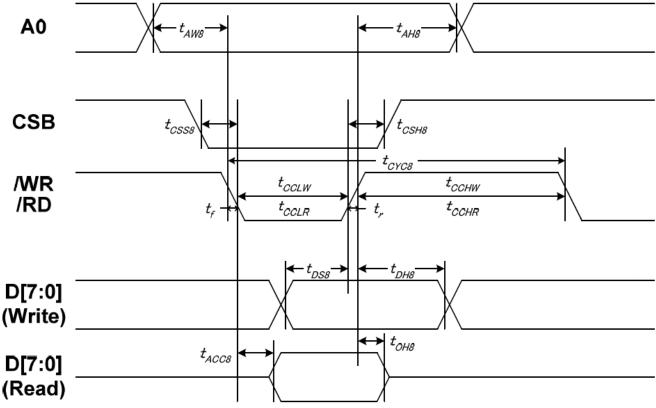
is extremely fast, (tr + tf) \leq (tCYC8 – tCCLW – tCCHW) for (tr + tf) \leq (tCYC8 – tCCLR – tCCHR) are

specified.

- 2. All timing is specified using 20% and 80% of VDDI as the reference.
- 3. tCCLW and tCCLR are specified as the overlap between CSB being "L" and /WR and /RD being at the

"L" level.CSB and /WR (or /RD) cannot act at the same time and CSB should be 100ns wider than /WR (or /RD).

7.2. System Bus Timing for 8080 Series MPU



Item	Signal	Symbol	Condition	Min	Max	Unit
Address setup time	40	tAW8	-	10	-	
Address hold time	A0	tAH8	-	0	-	
System cycle time		tCYC8	-	200	-	
/WR L pulse width (WRITE)	/WR	tCCLW	-	100	-	
/WR H pulse width (WRITE)		tCCHW	-	100	-	
/RD L pulse width (READ)	/DD	tCCLR	-	120	-	
/RD H pulse width (READ)	/RD	tCCHR	-	120	-	ns
CSB setup time	CSB	tCSS8	-	100	-	
CSB hold time	CSB	tCSH8	-	100	-	
Write data setup time		tDS8	-	70	-	
Write data hold time	D[7.0]	tDH8	-	20	-	
Read data access time	D[7:0]	tACC8	CL = 100 pF	-	80	
Read data output disable time	1	tOH8	CL = 100 pF	15	80	

Note:

1. The input signal rise time and fall time (tr, tf) is specified at 15 ns or less. When the system cycle time

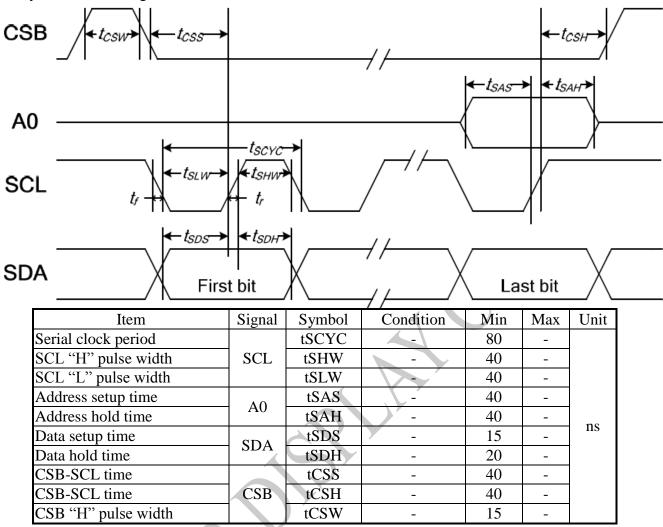
is extremely fast, $(tr + tf) \le (tCYC8 - tCCLW - tCCHW)$ for $(tr + tf) \le (tCYC8 - tCCLR - tCCHR)$ are

specified.

- 2. All timing is specified using 20% and 80% of VDDI as the reference.
- 3. tCCLW and tCCLR are specified as the overlap between CSB being "L" and /WR and /RD being at the

"L" level.CSB and /WR (or /RD) cannot act at the same time and CSB should be 100ns wider than /WR (or /RD).

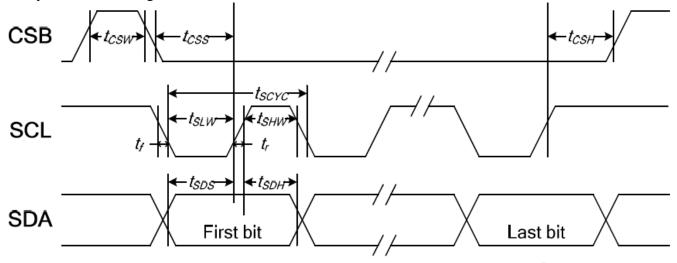
7.3. System Bus Timing for 4-Line Serial Interface



Note:

- 1. The input signal rise and fall time (tr, tf) are specified at 15 ns or less.
- 2. All timing is specified using 20% and 80% of VDDI as the standard.

7.4. System Bus Timing for 3-Line Serial Interface



Item	Signal	Symbol	Condition	Min	Max	Unit
Serial clock period		tSCYC		80	-	
SCL "H" pulse width	SCL	tSHW	1	40	-	
SCL "L" pulse width		tSLW	- >	40	-	
Data setup time	SDA	tSDS	V-Y	15	-	nc
Data hold time	SDA	tSDH	-	20	-	ns
CSB-SCL time		tCSS	-	40	-	
CSB-SCL time	CSB	tCSH	-	40	-	
CSB "H" pulse width		tCSW	-	15	-	

Note:

- The input signal rise and fall time (tr, tf) are specified at 15 ns or less.
 All timing is specified using 20% and 80% of VDDI as the standard.

8.Optical Characteristics

Item		Symbol	Temp	Condition.	Min	Typ.	Max.	Unit	Remark	
Dagnanga tima		Tr	25℃	θ=0°, Φ=0	-	35	-	me	Note 3	
Response time	Response time		25℃	$0-0$, $\Phi=0$	-	-		.ms	Note 3	
Contrast ratio		CR	25℃	At optimized viewing angle	-	900	-	-	Note 4	
	Hor.	ΘR	25℃		80			Dog		
Viewing angle	1101.	ΘL	25℃	CR≧10	80				Note 1	
(Gray Scale Inversion Direction)	Ver.	ΦВ	25°C		Deg.	Note 2				
Bricetion	ver.	ΦТ	25℃			80	80			
Brightness		-	25℃	-	400	500	9.	cd/m ²	Center of display	

Ta=25±2°C, IL=160mA

Note 1: Definition of viewing angle range

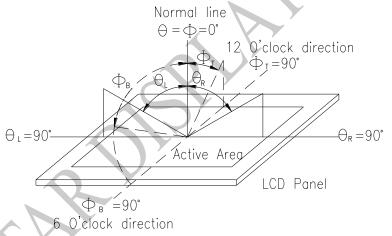


Fig. 8.1. Definition of viewing angle

Note 2: Test equipment setup: After stabilizing and leaving the panel alone at a driven temperature for 10 minutes, the measurement should be executed. Measurement should be executed in a stable, windless, and dark room. Optical specifications are measured by Topcon BM-7(BM-5) luminance meter 1.0° field of view at a distance of 50cm and normal direction.

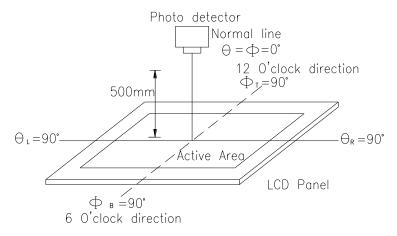
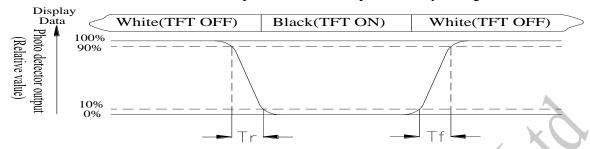


Fig. 8.2. Optical measurement system setup



Note 3: Definition of Response time:

The response time is defined as the LCD optical switching time interval between "White" state and "Black" state. Rise time, Tr, is the time between photo detector output intensity changed from 90% to 10%. And fall time, Tf, is the time between photo detector output intensity changed from 10% to 90%



Note 4: Definition of contrast ratio:

The contrast ratio is defined as the following expression.

Contrast ratio (CR) = Luminance measured when LCD on the "White" state

Luminance measured when LCD on the "Black" state

Note 5: White $Vi = Vi50 \pm 1.5V$

Black $Vi = Vi50 \pm 2.0V$

"±" means that the analog input signal swings in phase with VCOM signal.

"±" means that the analog input signal swings out of phase with VCOM signal.

The 100% transmission is defined as the transmission of LCD panel when all the input terminals of module are electrically opened.

Note 6: Measured at the center area of the panel when all the input terminals of LCD panel are electrically opened.

9.Interface

9.1. LCM PIN Definition

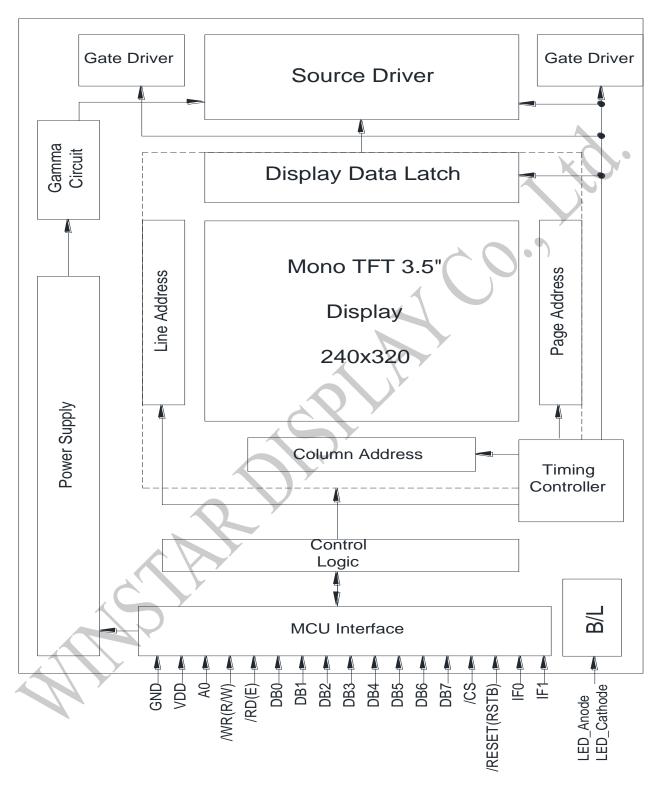
Pin	Symbol	Function	Remark				
1	GND	System ground					
2	VDD	Power Supply: +3.3V					
3	NC	No connect					
4	A0	Data/Command select					
5	/WR(R/W)	Write strobe signal					
6	/RD(E)	Read strobe signal					
7	DB0	Data bus					
8	DB1	Data bus					
9	DB2	Data bus					
10	DB3	Data bus					
11	DB4	Data bus					
12	DB5	Data bus					
13	DB6	Data bus					
14	DB7	Data bus					
15	/CS	Chip select					
16	/RESET(RSTB)	Hardware reset					
17	IF0	Mode select	Note 1				
18	IF1	Wide select	Note1				
19	A	LED +					
20	K	LED -					
21	NC	No connect					
22	NC	No connect					

Note1:

Setting		MCUTyma	Interface Pin Function				
IF1	IF0	MCU Type	CSB	A0	RWR	ERD	D[7:0]
L	L	Parallel 8080 series MCU			/WR	/RD	D[7:0]
L	Н	Parallel 6800 series MCU	CSB	A0	R/W	Е	D[7.0]
Н	Н	Serial 4-Line series MCU	CSD		-	-	D7=SCL, D0=SDA, D[6:1] are
Н	L	Serial 3-Line series MCU		-	-	-	not used

The un-used pins are marked as "-" and should be connected to "H" by VDDI.

10.Block Diagram



11.Reliability

Content of Reliability Test (Super Wide temperature, -30° C $\sim 80^{\circ}$ C)

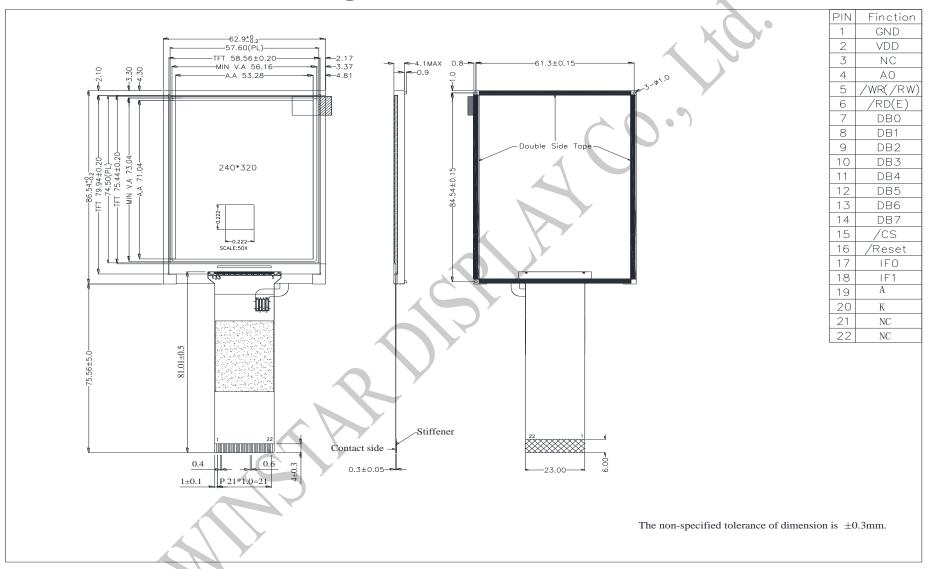
Environmental Test			
Test Item	Test Condition	Note	
High Temperature	Endurance test applying the high storage	80°C	2
storage	temperature for a long time.	200hrs	
Low Temperature	Endurance test applying the low storage	-30°C ▲	1,2
storage	temperature for a long time.	200hrs	
High Temperature	Endurance test applying the electric stress	80°C	X
Operation	(Voltage & Current) and the thermal stress to the element for a long time.	200hrs	
Low Temperature	Endurance test applying the electric stress under	-30°C	1
Operation	low temperature for a long time.	200hrs	
High Temperature/	The module should be allowed to stand at 60	60°C,90%RH	1,2
Humidity storage	°C,90%RH max	96hrs	
Thermal shock	The sample should be allowed stand the	-30°C/80°C	
resistance	following 10 cycles of operation	10 cycles	
	-30°C 25°C 80°C		
	30min 5min 30min 1 cycle		
Vibration test	Endurance test applying the vibration during	Total fixed	3
	transportation and using.	amplitude: 15mm	
		Vibration Frequency: 10~55Hz	
	Y	One cycle 60 seconds	
		to 3 directions of	
		X,Y,Z for Each 15	
	XYY	minutes	
Static electricity test		VS=±600V(contact),	
	terminal.	±800v(air),	
	\mathcal{C}	$RS=330\Omega$	
		CS=150pF	
	angation to be observed	10 times	<u> </u>

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

12.Contour Drawing



13.Initial Code For Reference

```
void Initial code()
    Write_Command(0xae);
    Write_Data(0xa5);
    Write_Command(0x61);
    Write Data(0x8f);
    Write_Data(0x04);
    Write Data(0xa5);
    Write_Data(0xa5);
    Write_Command(0x62);
    Write_Data(0x42);
    Write_Data(0x0b);
    Write_Data(0x0c);
    Write_Data(0xa5);
    Write_Command(0x33);
    Write_Data(0x07);
    Write Data(0x2c);
    Write_Data(0x09);
    Write_Data(0x2a);
    Write_Command(0x63);
    Write Data(0x09);
    Write_Data(0x17);
    Write Data(0xa5);
    Write_Data(0xa5);
    Write_Command(0x24);
    Write_Data(0x01);
    Write Data(0xa5);
    Write Data(0xa5);
    Write Data(0xa5);
    Write Command(0x22);
    Write Data(0x00);
    Write_Data(0xa5);
    Write_Data(0xa5);
    Write_Data(0xa5);
    Write Command(0x91);
    Write_Data(0x00);
    Write Data(0x17);
    Write_Data(0x1b);
```

```
Write_Data(0x1d);
Write Command(0x92);
Write Data(0x1f);
Write Data(0x21);
Write_Data(0x23);
Write Data(0x25);
Write Command(0x93);
Write_Data(0x27);
Write_Data(0x29);
Write Data(0x2a);
Write_Data(0x2c);
Write_Command(0x94);
Write Data(0x2e);
Write Data(0x31);
Write_Data(0x34);
Write_Data(0x3f);
Write Command(0x99);
Write_Data(0x00);
Write_Data(0x17);
Write_Data(0x1b);
Write_Data(0x1d);
Write_Command(0x9a);
Write_Data(0x1f);
Write Data(0x21);
Write_Data(0x23);
Write Data(0x25);
Write_Command(0x9b);
Write Data(0x27);
Write_Data(0x29);
Write_Data(0x2a);
Write_Data(0x2c);
Write_Command(0x9c);
Write_Data(0x2e);
Write Data(0x31);
Write_Data(0x34);
Write_Data(0x3f);
    Write_Command(0x12);
    Write Data(0xa5);
    Write_Command(0x15);
    Write_Data(0xa5);
```

}

winstar	· LCM Samp	le Estimat	te Feedback Sheet
Modu	le Number :		Page: 1
1 · <u>P</u>	anel Specification:		
1.	Panel Type:	Pass	☐ NG ,
2.	View Direction:	Pass	☐ NG ,
3.	Numbers of Dots:	Pass	☐ NG ,
4.	View Area:	Pass	□ NG ,
5.	Active Area:	Pass	□ NG ,
6.	Operating Temperature:	Pass	□ NG ,
7.	Storage Temperature:	Pass	□ NG ,
8.	Others:		
2 · <u>N</u>	<u>Mechanical Specification</u> :		~ 0.7
1.	PCB Size:	Pass	□ NG ,
2.	Frame Size:	Pass	□ NG ,
3.	Material of Frame:	☐ Pass	□ NG ,
4.	Connector Position:	Pass	□ NG ,
5.	Fix Hole Position:	Pass	□ NG ,
6.	Backlight Position:	☐ Pass	□ NG ,
7.	Thickness of PCB:	☐ Pass	□ NG ,
8.	Height of Frame to PCB:	☐ Pass	☐ NG ,
9.	Height of Module:	☐ Pass	☐ NG ,
10.	Others:	☐ Pass	☐ NG ,
3 · <u>R</u>	Relative Hole Size :		
1.	Pitch of Connector:	☐ Pass	□ NG ,
2.	Hole size of Connector:	☐ Pass	☐ NG ,
3.	Mounting Hole size:	☐ Pass	☐ NG ,
4.	Mounting Hole Type:	Pass	□ NG ,
5.	Others:	Pass	☐ NG ,
4 > <u>B</u>	acklight Specification:		
1.	B/L Type:	Pass	□ NG ,
2.	B/L Color:	Pass	□ NG ,
3.	B/L Driving Voltage (Refere	nce for LED	Type): Pass NG,
4.	B/L Driving Current:	☐ Pass	□ NG ,
5.	Brightness of B/L:	Pass	□ NG ,
6	B/L Solder Method:	□ Pass	\square NG.

WF35NTVAJDNN0#

Pass

7. Others:

□ NG ,_____

第23頁,共24頁

>> Go to page 2 <<

insta	- ar						
Iodule Number :			Page: 2				
5 、	Electronic Characteristics of	Module:					
1.	Input Voltage:	Pass	□ NG ,				
2.	Supply Current:	Pass	□ NG ,				
3.	Driving Voltage for LCD:	Pass	□ NG ,				
4.	Contrast for LCD:	Pass	□ NG ,				
5.	B/L Driving Method:	Pass	□ NG ,				
6.	Negative Voltage Output:	Pass	□ NG ,				
7.	Interface Function:	Pass	□ NG,				
8.	LCD Uniformity:	☐ Pass	□ NG ,				
9.	ESD test:	☐ Pass	□ NG ,				
10.	Others:	Pass	□ NG,				
6、	Summary:						
	Sales signature : Customer Signature :	, č	Date: / /				
	Castollici Signature .		Date . I				